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ASURT Task 02  
Power electronics  
Session

### Switches Types

Diode

Mosfet

BJT

IGBT

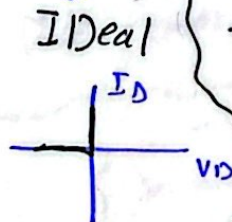
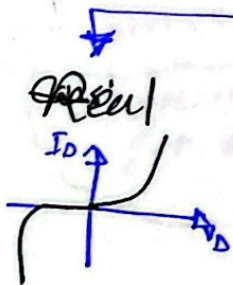
others

• Diode

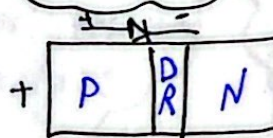
Symbol



Characteristics

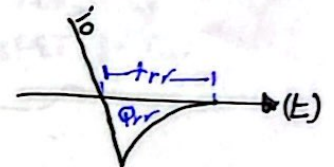


Construction



2 materials called are put together to form a PN Junction which separates between them a depletion Region

Diode Reverse Recovery



The current  $I$  Required to sweep out the excess carriers and allow the diode to block the (-ve) polarity from occurs

	General Purpose	Fast recovery	shot key
switching (F)	Low	Highest	High
Ratings	Highest	Medium	Low
V drop	Low	medium	Lowest
APP	Low (F) APPS	High (F) apps	Low (V) out



## Types of Transistors

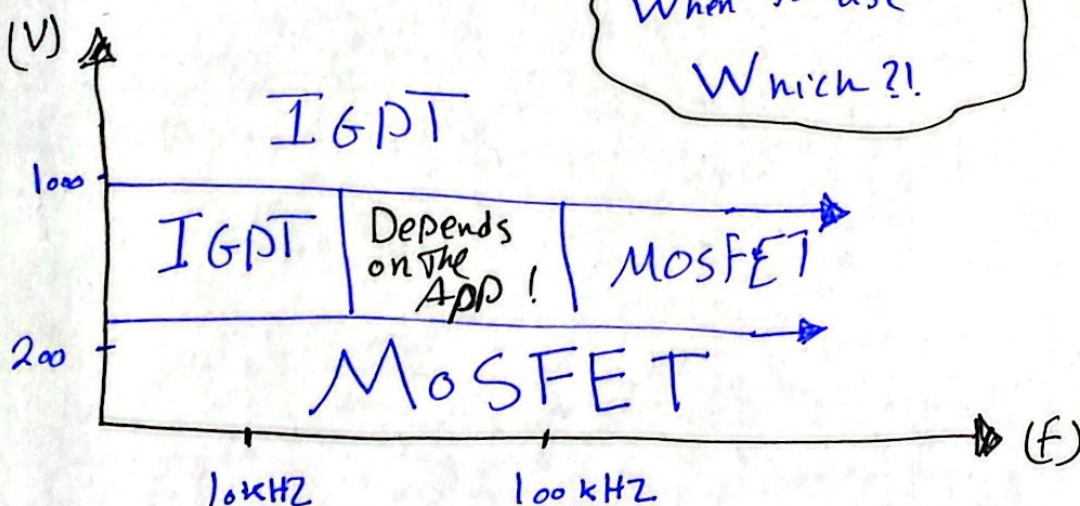
	* MOSFET *	* IGBT *	BJT
Control Method	Voltage Controlled	Voltage Controlled	Current Controlled
Power Capability	Low	Medium	Medium
Switching Speed	High	Medium	Medium
Temp Coefficient	Positive	Depends on design	Negative
Inherent body Diode	Exists	Absent	Absent

### Temperature coefficient

It means how the transistor resistance get effected by the temperature

The most preferred transistors types in today's industry are MOSFET & IGBT

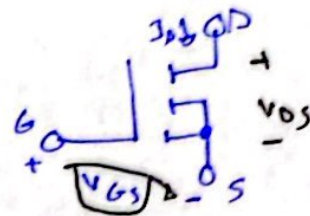
When to use  
Which?!





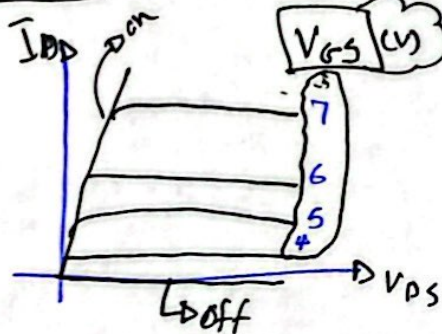
What is MOSFET

→ symbol

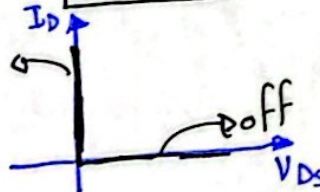


## Characteristics

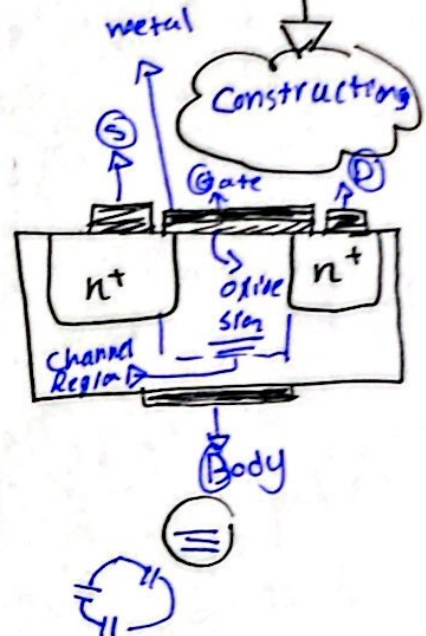
Real



✓  
Ideal



Constructing



# MosFET losses

Conduction losses

\* During ON Time MOSFET acts like a resistor

$$P = I_{(rms)}^2 R_{ds on}$$

## Diode Losses

\* The conduction losses of the anti-parallel Diode can be estimated using Diode DC approx

$P = U_{DO} \cdot I_{Fav} \cdot R_{D1}^{-2} \cdot I_{Fm}^{-2}$   
No. 7  $\swarrow$   $\searrow$   
 Average  $\swarrow$   $\searrow$   
 Forward  $\swarrow$   $\searrow$   
 current  $\swarrow$   $\searrow$   
 but  $\swarrow$   $\searrow$   
 Rm

Switching losses

$$W_c = \frac{1}{2} V_D I_O (t_{\text{on}} + t_{\text{c(off)}})$$

$$P_s = \frac{W_c}{T_s} = W_c f_s = \frac{1}{2} V_0 I_0 (\tan^{-1} T_0)$$

To reduce the switching losses  
reduce  $F$  or  $T_{on}$  &  $t_{off}$